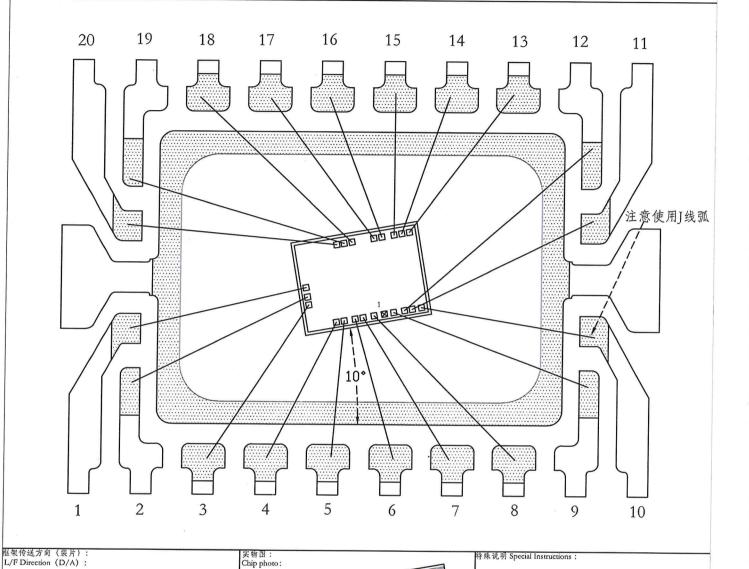
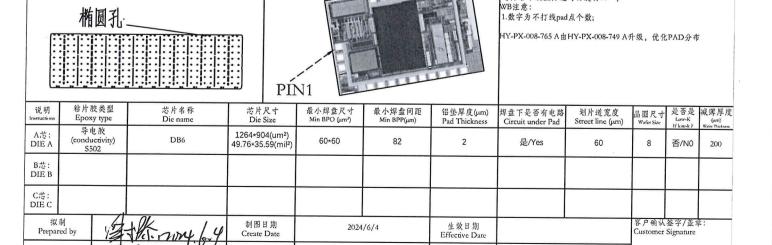
池州华宇电子科技股份有限公司				客户代码 Customer No.	008	线图号 Drawing No.	HY-PX-008-765 A	
焊线图纸 Bonding Diagram			产品名称 Product Type	HS5146_M5 對裝外型 PKG Type		TSSOP20		
焊线种类 Wire Type	焊线直径(μm) Wire Diameter	焊线根数 NO. of wire	焊线总长(μm) Total wire length	最长线长(μm) Longest wire length	最短线长(μm)_ Shortest wire length			LF载体尺寸 LF Pad Size
合金丝 Ag	20	20	42069	2570		首选(Preferred): EME-G630AY 备选(Optional):		TSSOP20L-8R (118X165mil <sup>2</sup> ) (3000X4200um <sup>2</sup> )
客户图号 Customer drawin	g NO.							





批准

Approved by

DB注意:

芯片居中放置并逆时针旋转10°;

·温馨模示:图纸为产品下线生产的唯一依据,请您认真确认,我司依据您回签后的图纸生产,如图纸错误会产生不可估量损失,谢谢!
warm tips: the drawing is the only basis for the production of the product. Please confirm it carefully. Our company will produce the drawings according to the drawings you have signed back, such as drawing mistakes, which will produce inestimable loss. Thank you

品工程审核

PE Check

研发审核 R&D Check

> 页码 Page 1/1